

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : **Confirmation No. 6334**  
Koji MISHIMA et al. : Docket No. 2003\_1305  
Serial No. 10/660,483 : Group Art Unit 1742  
Filed September 12, 2003 : Examiner William T. Leader



METHOD AND APPARATUS FOR  
PLATING SUBSTRATE WITH COPPER

**Mail Stop: Amendment**

**AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

THE COMMISSIONER IS AUTHORIZED  
TO CHARGE ANY DEFICIENCY IN THE  
FEES FOR THIS PAPER TO DEPOSIT  
ACCOUNT NO. 23-0975

Sir:

Responsive to the Office Action of December 15, 2004, a Petition for a one-month extension of time being filed concurrently herewith, please amend the above-identified application as follows.